

NOTES:

MATERIAL:

1. HOUSING MATERIAL :GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL :PHOSPHOR BRONZE $t=0.30\text{mm}$.
3. PLATING :SELECTING GOLD PLATING $1\mu\sim 50\mu$ OVER NICKEL IN CONTACT AREA. 150μ TIN PLATING OVER NICKEL IN SOLDER AREA

ELECTRICAL:

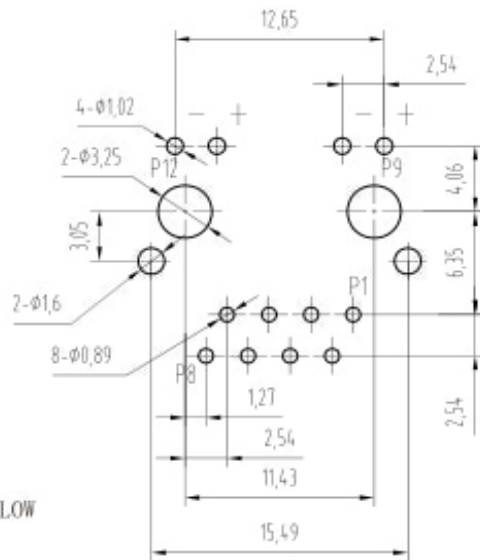
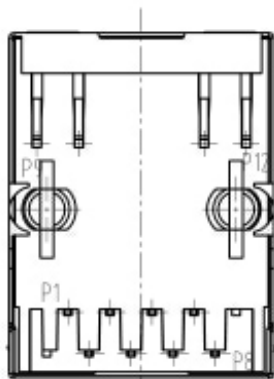
1. VOLTAGE RATING :125 VAC RMS.
2. CURRENT RATING :1.5 AMP.
3. CONTACT RESISTANCE :30 MILLIOHMS MAX.
4. INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC WITHSTANDING RESISTANCE :1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

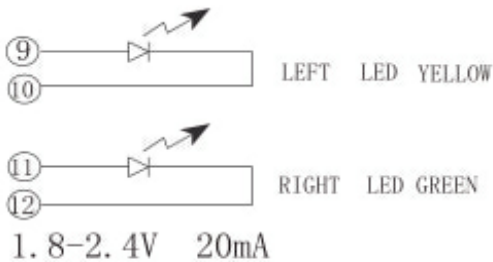
1. DURRABILITY: :750 CYCLES MIN.
2. PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40° C TO 85° C.
2. OPERATION : 0° C TO 70° C.



PC Board Layout
Component Side Shown



SHENZHEN KINGHELM ELECTRONIC CO., LTD.				WWW.BDS666.COM			
KH-5922S-8P8C-D				0755-83044319			
(units)	MM	(draw)	DENG HUIJIAN	(nt 1)	(name)	RJ45 JACK 90° Shielding tape lamp	
(scale)	1 : 1	(ch'k)	ZHU JINAHUA	UNIT:mm xx +/0.25, xxx +/-0.13	(Part number)	5922S- 8P8C-1X1	
(rev.)	A / 1	(app'd)	ZHU JINAHUA	HOUSING	(File Name)	E:\Engineering drawing	
(view)		(date)	2008.08.12	PIX	Qsn6.5-0.1		